PRELIMINARY SPEC



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Features

- 3.0MM X 2.0MM, 1.4MM HIGH, ONLY MINIMUM SPACE REQUIRED.
- SUITABLE FOR COMPACT OPTOELECTRONIC APPLICATIONS.
- LOW POWER CONSUMPTION.
- PACKAGE : 2000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- ELECTROSTATIC DISCHARGE THRESHOLD (HBM):1000V.
- TYP. COLOR TEMPERATURE: 6500K
- COLOR COORDINATES:X=0.31,Y=0.31 ACC. TO CIE1931(WHITE).
- OPTICAL EFFICIENCY: 51.6 lm/W(TYP.)
- COLOR REPRODUCTION INDEX: 80
- RoHS COMPLIANT.

3.0x2.0mm SURFACE MOUNT LED LAMP

WHITE

Part Number: AA3020RWS/Z

Description

The source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDS.

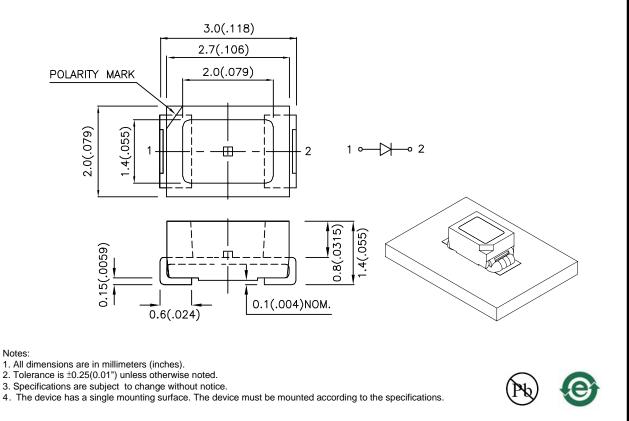
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Applications

- traffic signaling.
- backlighting (illuminated advertising , general lighting).
- interior and exterior automotive lighting.
- substitution of micro incandescent lamps.
- reading lamps.
- signal and symbol luminaire for orientation.
- marker lights (e.g. steps, exit ways, etc).
- decorative and entertainment lighting.
- indoor and outdoor commercial and residential architectural lighting.

Package Dimensions

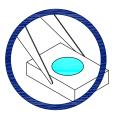


SPEC NO: DSAH4501 APPROVED: WYNEC REV NO: V.2 CHECKED: Allen Liu DATE: MAY/26/2007 DRAWN: S.J.LIU PAGE: 1 OF 8 ERP: 1201002983

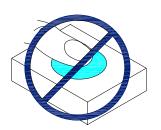
Handling Precautions

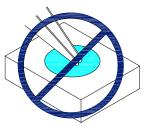
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

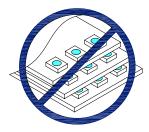


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

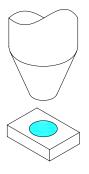




3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



4. During surface-mounting, the pickup capillary diameter should be larger than the silicone lens to insure the capillary does not scratch or damage the lens.



REV NO: V.2 CHECKED: Allen Liu DATE: MAY/26/2007 DRAWN: S.J.LIU PAGE: 2 OF 8 ERP: 1201002983

Selection Guid	e						
Part No.	Dice	Lens Type	luminous Intensity ^{Note2} Iv(mcd) @ 20mA		Φν (mlm) ^{Note3} @ 20mA		Viewing Angle ^{Note1}
			Min.	Тур.	Min.	Тур.	201/2
AA3020RWS/Z	WHITE (InGaN)	WATER CLEAR	650	1200	1500	3300	120°

Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	Value	Unit
Power dissipation	Pt	111	mW
Reverse Voltage	VR	5	V
Junction temperature	TJ	110	٥°C
Operating Temperature	Тор	-40 To +85	٥°C
Storage Temperature	Tstg	-40 To +100	°C
DC Forward Current	lF	30	mA
Peak Forward Current Note4	Іғм	100	mA
Thermal resistance Junction/ambient ^{Note5} Junction/solder point	Rth JA Rth JS	300 140	°C/W °C/W

Notes:

1.01/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

2.Luminous intensity is measured by a current pulse of 10ms at a tolerance of $\pm 15\%$.

3. The typical data of Luminous Flux can only reflect statistical figures, actual parameters of individual product could differ from the typical data. For the purpose of product enhancement, the typical data is subject to change without prior notice.

4.1/10 Duty Cycle, 0.1ms Pulse Width. 5.Rth(J-A) Results from mounting on PC board FR4 (pad size≥16 mm² per pad),

Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Value	Unit	
Chromaticity coordinate x acc.to CIE1931 IF=20mA [Typ.]	X ^{Note1}	0.31	-	
Chromaticity coordinate y acc.to CIE1931 IF=20mA [Typ.]	Y Note1	0.31	-	
Forward Voltage IF=20mA [Min.]		2.7		
Forward Voltage IF=20mA [Typ.]	VF Note2	3.2	V	
Forward Voltage IF=20mA [Max.]		3.7		
Reverse Current (VR=5V) [Typ.]	- IR	0.01		
Reverse Current (VR=5V) [Max.]	IK	10	μΑ	
Temperature coefficient of x IF=20mA, -10°C≤ T≤100°C [Typ.]	TC x	-0.1	10 ⁻³ /°C	
Temperature coefficient of y IF=20mA, -10°C≤ T≤100°C [Typ.]	ТСу	-0.2	10 ⁻³ /°C	
Temperature coefficient of VF IF=20mA, -10°C \leq T \leq 100°C [Typ.]	ΤCv	-2.5	mV/°C	

Notes:

1.Chromaticity coordinates are measured by a current pulse of 20ms with a tolerance of ±0.01 in X and Y color coordinates.

2.Forward voltage is measured with a current pulse of 10ms at a tolerance of ±0.1V.

Brightness codes

	Φv (mlm) ^{Note2} @ 20mA		
Code.	Min.	Max.	Тур.
Т	650	1200	3260
U	900	1500	3350
V	1200	1800	3400

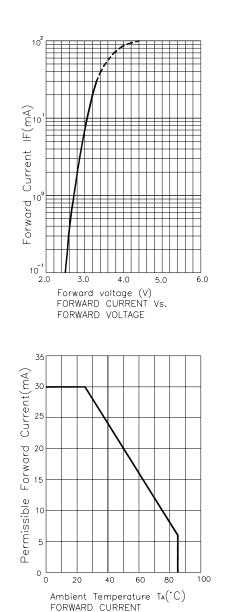
Notes:

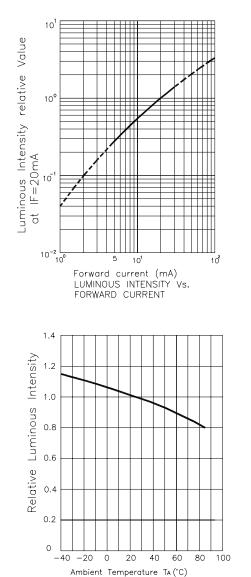
1.Luminous intensity is measured by a current pulse of 10ms at a tolerance of \pm 15%.

2. The typical data of Luminous Flux can only reflect statistical figures, actual parameters of individual product could differ from the typical data. For the purpose of product enhancement, the typical data is subject to change without prior notice.

White

AA3020RWS/Z





PAGE: 4 OF 8 ERP: 1201002983

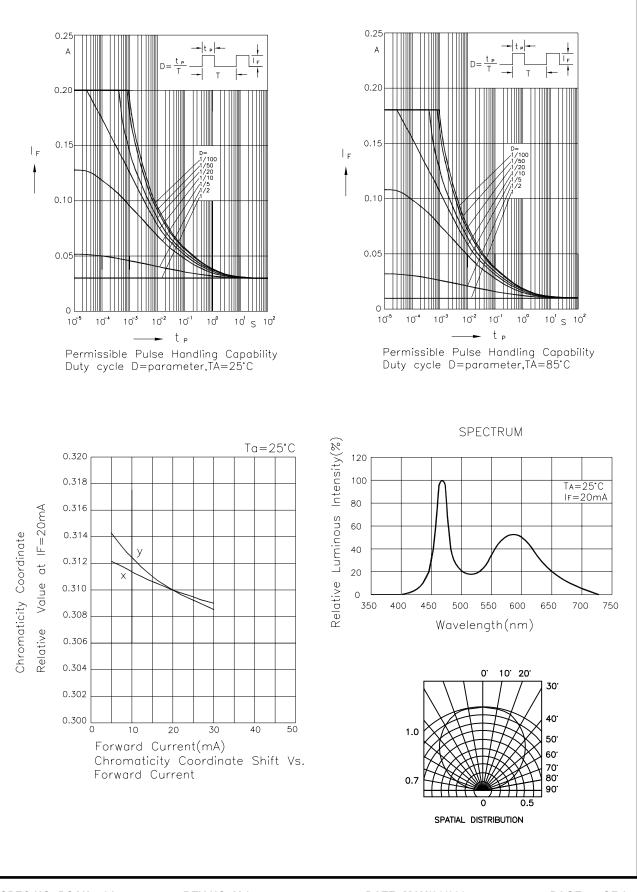
SPEC NO: DSAH4501 APPROVED: WYNEC REV NO: V.2 CHECKED: Allen Liu

DERATING CURVE

DATE: MAY/26/2007 DRAWN: S.J.LIU

LUMINOUS INTENSITY VS. AMBIENT TEMPERATURE

AA3020RWS/Z



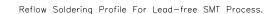
SPEC NO: DSAH4501 APPROVED: WYNEC REV NO: V.2 CHECKED: Allen Liu DATE: MAY/26/2007 DRAWN: S.J.LIU PAGE: 5 OF 8 ERP: 1201002983

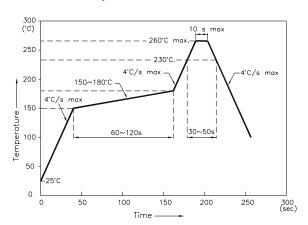
AA3020RWS/Z White CIE 0.44 0.42 0.40 c1 0.38 0.36 b4 c0 0.34 b b3 0.32 b2 0.30 a1 0.28 a0 0.26 0.24 0.22 $0.22 \quad 0.24 \quad 0.26 \quad 0.28 \quad 0.30 \quad 0.32 \quad 0.34 \quad 0.36 \quad 0.38 \quad 0.40 \quad 0.42 \quad 0.44$ a0 a1 0.264 0.283 0.296 0.280 0.248 0.275 0.283 0.264 Х Х Y 0.267 0.305 0.276 0.248 Y 0.286 0.321 0.305 0.267 Reference CCT: 14000~9000k Reference CCT: 14000~9000k b2 **b1** 0.330 0.330 0.287 0.330 0.330 0.296 Х 0.283 0.287 Х Y 0.305 0.360 0.339 0.295 0.295 0.339 0.318 0.276 Y Reference CCT: 9000~5600k Reference CCT: 9000~5600k b3 b4 0.275 0.298 0.306 0.298 0.321 0.330 0.306 Х 0.283 Х Y 0.321 0.350 0.332 0.305 Y 0.350 0.379 0.360 0.332 Reference CCT: 9000~7000k Reference CCT: 7600~5600k **c**0 c1 0.330 0.361 0.356 0.330 Х 0.321 0.366 0.361 0.330 Х Y 0.360 0.385 0.351 Υ 0.379 0.385 0.360 0.318 0.419

Reference CCT: 6000~4600k

Reference CCT: 5600~4600k







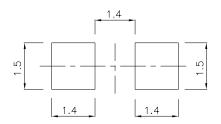
NOTES: 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.

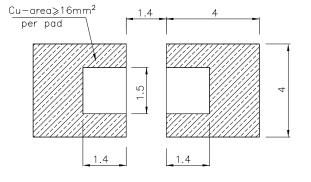
2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units : mm; Tolerance: ±0.1)

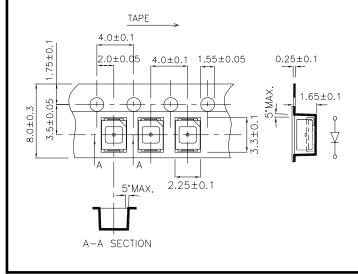
Pad design for improved heat dissipation





Tape Specifications (Units : mm)





12[0.472]±0.5 উ R6.5[0.256]±0 1<u>8[.709] ±0.</u>2 ø178[7.008]±1 / R36[1.4

ø60[2.362] ø56[2.205] 9[0.354]±0.2

Solder resist

SPEC NO: DSAH4501 **APPROVED: WYNEC**

REV NO: V.2 **CHECKED: Allen Liu** DATE: MAY/26/2007 **DRAWN: S.J.LIU**

PAGE: 7 OF 8 ERP: 1201002983

